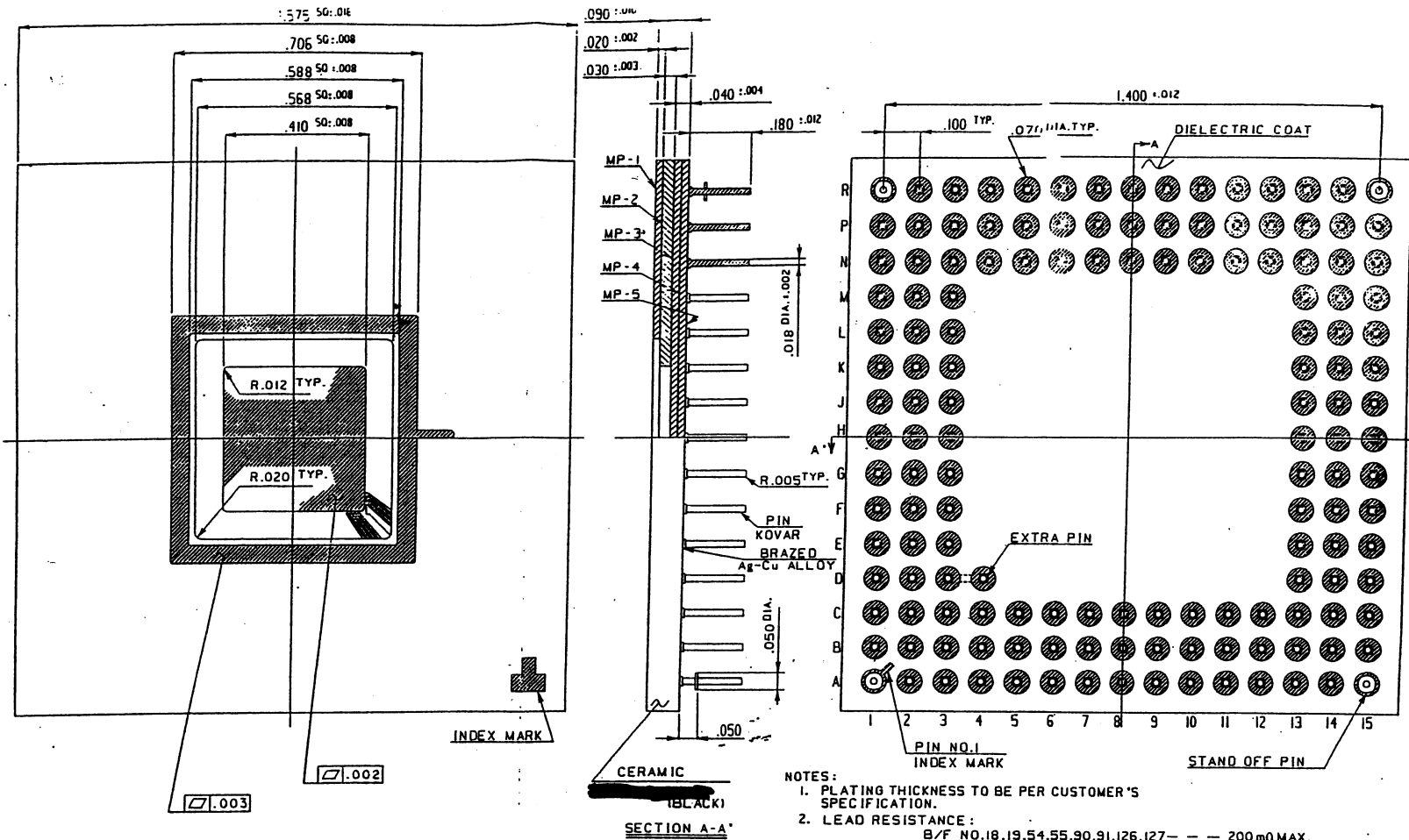


SSM P/N CPG14442



- NOTES:
1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
 2. LEAD RESISTANCE:
 - B/F NO.18,19,54,55,90,91,126,127 --- 200mΩ MAX.
 - B/F NO.1,37,73,109 --- 250mΩ MAX.
 - THE OTHERS --- 800mΩ MAX.
 3. SEAL AREA TO BE METALLIZED.
 4. DIE ATTACH AREA TO BE METALLIZED.
 5. SEAL RING AND DIE ATTACH PAD TO BE FLOATING FROM ANY PINS.

P/N P6A1442

MODIFICATION				NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
				145 PIN GRID ARRAY PACKAGE	UNLESS OTHERWISE SPECIFIED	H.T	K.K	M.K	MAR.10.'89
				SCALE 5/1	MATERIAL AS INDICATED	TYPING NO.			SHEET
						CPG14442			1/3
CHANGED				DATE	DRAWN	CHECKED	APPROVED		



